

VEHICULAR 2015

Committee

VEHICULAR 2015 Advisory Committee

Sriram Chellappan, Missouri University of Science and Technology, USA
João Dias, Universidade de Aveiro, Portugal
Carl James Debono, University of Malta - Msida, Malta
Hassan Ghasemzadeh, Washington State University, USA
Johan Lukkien, Eindhoven University of Technology, The Netherlands
Matthias Uwe Pätzold, University of Agder - Grimstad, Norway
Tapani Ristaniemi, University of Jyväskylä, Finland
Hwangjun Song, POSTECH (Pohang Univ of Science and Technology) - Pohang, Korea

VEHICULAR 2015 Industry/Research Chairs

Alexandre Bouard, BMW Forschung und Technik GmbH, Germany
Daniel Jiang, Mercedes-Benz Research & Development North America, USA
Peter Knapik, Volkswagen AG, Germany
An He, Qualcomm, USA
Khelifa Hettak, Industry Canada / Communications Research Centre - Nepean, Canada
Wenjing Wang, Blue Coat Systems, Inc., USA

VEHICULAR 2015 Publicity Chairs

Sangmi Moon, Chonnam National University, South Korea

VEHICULAR 2015 Technical Program Committee

Taimoor Abbas, Volvo Car Corporation, Sweden
Aydin Akan, Istanbul University, Turkey
Waleed Alasmari, University of Toronto, Canada
Marica Amadeo, University of Reggio Calabria, Italy
Andrea Baiocchi, SAPIENZA University of Rome, Italy
Irina Balan, Ghent University - IBBT, Belgium
Gaurav Bansal, Toyota InfoTechnology Center, USA
Michel Basset, Université de Haute Alsace, France
Melike Baykal-Gursoy, Rutgers University, USA
Monique Becker, Institut Mines Telecom, France
Luis Bernardo, Universidade Nova of Lisboa, Portugal

Yuanguo Bi, Northeastern University, China
Sebastian Bittl, Fraunhofer ESK Munich, Germany
Pascal Bodin, Orange Labs, France
Ghaleb Bolos, ESIGELEC, France
Mélanie Bouroche, Trinity College Dublin, Ireland
Robert Budde, TU Dortmund University, Germany
Darcy M. Bullock, Purdue University, USA
Chiara Buratti, DEIS, University of Bologna, Italy
Maria Calderon, University Carlos III of Madrid, Spain
Claudia Campolo, University of Reggio Calabria, Italy
Jean Pierre Cances, University of Limoges, France
Juan-Carlos Cano, Universitat Politecnica de Valencia, Spain
Lien-Wu Chen, Feng Chia University - Taichung, Taiwan
Ray-Guang Cheng, National Taiwan University of Science and Technology - Taipei, Taiwan, R.O.C.
Yonggang Chi, Harbin Institute of Technology, China
Dong Ho Cho, Korea Advanced Institute of Science and Technology - Daejeon, Republic of Korea
Baldomero Coll-Perales, Miguel Hernandez University of Elche, Spain
Juan Antonio Cordero Fuertes, INRIA, France
Naim Dahnoun, University of Bristol, UK
David de Andrés, Universitat Politècnica de València, Spain
Carl James Debono, University of Malta - Msida, Malta
David Hung-Chang Du, University of Minnesota, USA
Trung Q. Duong, Blekinge Institute of Technology, Sweden
Weiwei Fang (方维维), Beijing Jiaotong University (BJTU) - Beijing, China
Michel Ferreira, University of Porto and Instituto de Telecomunicações, Portugal
Alois Ferscha, Institut für Pervasive Computing, Johannes Kepler Universität Linz, Austria
Serge Fdida, UPMC Sorbonne University, France
Emma Fitzgerald, Lund University, Sweden
Malgorzata Gajewska, Gdańsk University of Technology, Poland
Slawomir Gajewski, Gdańsk University of Technology, Poland
Piedad Garrido Picazo, University of Zaragoza, Spain
Hassan Ghasemzadeh, Washington State University, USA
Athanasios Gkelias, Imperial College London, UK
Benjamin Glas, ETAS GmbH, Germany
Javier Gozalvez, UWICORE Laboratory, University Miguel Hernandez of Elche, Spain
An He, Qualcomm, USA
Khelifa Hettak, Industry Canada / Communications Research Centre - Nepean, Canada
Daesik Hong, Yonsei University - Seoul, Korea
Javier Ibanez-Guzman, Renault S.A., France
Satish Chandra Jha, Intel Corporation, USA
Daniel Jiang, Mercedes-Benz Research & Development North America, USA
Felipe Jimenez, Technical University of Madrid (UPM), Spain

Georgios Karagiannis, University of Twente, The Netherlands
Gunes Karabulut Kurt, Istanbul Technical University - Istanbul, Turkey
Frank Kargl, University of Ulm, Germany
Wolfgang Kiess, DOCOMO Euro-Labs, Germany
Jungwoo Lee, Seoul National University, Korea
XiangYang Li, Illinois Institute of Technology - Chicago, USA
Qilian Liang, University of Texas at Arlington, USA
Thomas Little, Boston University, USA
Rongxing Lu, University of Waterloo, Canada
Johan Lukkien, Eindhoven University of Technology, The Netherlands
Johann M. Marquez-Barja, CTVR / Trinity College Dublin, Ireland
Francisco J. Martinez, University of Zaragoza, Spain
Barbara M. Masini, CNR - IEIIT, University of Bologna, Italy
João Mendes-Moreira, Universidade do Porto and LIAAD-INESC TEC L.A., Portugal
Ingrid Moerman, Ghent University - IBBT, Belgium
John Morris, Mahasarakham University, Thailand
Hidekazu Murata, Kyoto University, Japan
Jose Eugenio Naranjo Hernandez, Universidad Politecnica de Madrid, Spain
Kenneth S. Nwizege, Rivers State Polytechnic, Nigeria
Arnaldo Oliveira, Universidade de Aveiro, Portugal
Shumao Ou, Oxford Brookes University, UK
Philippe Palanque, IRIT, France
Mohammad Patwary, Staffordshire University, UK
Matthias Uwe Pätzold, University of Agder - Grimstad, Norway
Marco Picone, University of Parma, Italy
Adrian Popescu, Blekinge Institute of Technology - Karlskrona, Sweden
Ravi Prakash, University of Texas at Dallas, USA
M. Elena Renda, IIT - CNR - Pisa, Italy
Tapani Ristaniemi, University of Jyväskylä, Finland
Marco Roccetti, University of Bologna, Italy
Francesca Saglietti, University of Erlangen-Nuremberg, Germany
José Santa, University Centre of Defence at the Spanish Air Force Academy, Spain
Vitor Santos, University of Aveiro, Portugal
Susana Sargent, University of Aveiro, Portugal
Erwin Schoitsch, AIT Austrian Institute of Technology GmbH, Austria
Miguel Sepulcre, University Miguel Hernandez of Elche, Spain
Won-Yong Shin, Harvard University, USA
Sebastian Siegl, AUDI AG, Germany
Marcin Sokól, Gdansk University of Technology, Poland
Hwangjun Song, POSTECH (Pohang Univ of Science and Technology) - Pohang, Korea
Kemal Ertugrul Tepe, University of Windsor, Canada
Necmi Taspinar, Erciyes University - Kayseri, Turkey
Olav Tirkkonen, Aalto University, Finland
Theodoros A. Tsiftsis, Technological Educational Institute of Lamia, Greece

Carlo Vallati, University of Pisa, Italy
Rens W. van der Heijden, Institute of Distributed Systems - University of Ulm, Germany
Wantanee Viriyasitavat, Mahidol University, Thailand
Ljubo Vlasic, Griffith University, Australia
Wenjing Wang, Blue Coat Systems, Inc., USA
You-Chiun Wang, National Sun Yat-Sen University, Taiwan
Chih-Yu Wen, National Chung Hsing University - Taichung, Taiwan
Yue Wu, Shanghai Jiaotong University, China
Weidong Xiang, University of Michigan - Dearborn, USA
Jinyao Yan, Communication University of China, China
Zheng Yan, Aalto University - Espoo, Finland / Xidian University Xi'an, China
Wei Yuan, Huazhong University of Science and Technology - Wuhan, China
Peng Zhang, Xi`An University of Posts and Telecommunications (XUPT), China
Wensheng Zhang, Iowa State University, USA
Zhangbing Zhou, China University of Geosciences - Beijing, China & TELECOM SudParis, France
Haojin Zhu, Shanghai Jiao Tong University, China
Yanmin Zhu, Shanghai Jiao Tong University, China